EAST Search History

EAST Search History (Prior Art)

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
Si	8	CLEAVER-MATTHEW\$. IN.	US PCPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 08:20
\$2	4608580	mold\$3 or model\$3 or tool\$3 or cast\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 08:32
S3	4469540	adhesive or paste or glue or binder or resin or bonding	US PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 08:32
S4	9018516	cover\$3 or coat\$3 or encapsula\$11\$3 or seal \$3 or envelop\$3 or surround\$3	US PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 08:33
S5	5730898	layer\$3 or lamina\$4 or stack\$3 or multi\$1layer \$2 or lay\$1up or (lay\$3 up)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADU	ON	2008/10/21 08:33
S6	10802421	layer\$3 or lamina\$4 or stack\$3 or multi\$1layer \$2 or lay\$1up or (lay\$3 up) or sheet or block	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 08:38
S7	4608580	mold\$3 or model\$3 or tool\$3 or cast\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 08:39

S8	4469540	adhesive or paste or glue or binder or resin or bonding	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 08:39
S9	9018516	cover\$3 or coat\$3 or encapsula\$11\$3 or seal \$3 or envelop\$3 or surround\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	A DJ	ON	2008/10/21 08:39
S10	133	HUNTSMAN\$.AS. and S7 and S8 and S9 and S6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 08:39
S11	14	\$10 and ("156".clas. or "264".clas.)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 08:42
S12	204	264/642.cds. and (adhesive or paste or glue or binder or resin or bonding) and (mold \$3 or model\$3 or tool \$3 or cast\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 09:04
S13	162	S12 and (machin\$3 or grind\$3 or ground or abrad\$3 or abrasion or cut\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 09:05
S14	7	("4851061" "5354414" "5637169" "5653925").PN. OR ("5948342").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2008/10/21 09:21
S15	9	(6077886 3861936 3652486 6060540 5942182 5707477 5773047 5859096).pn.	US-PGPUB; USPAT; USOCR	ADJ	ON	2008/10/21 09:39
S16	8	("3418695" "4255364" "4680216" "4803108" "5045575" "5139843").PN. OR ("5707477").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2008/10/21 09:48

S17	13	("3418695" "4620890" "4620890" "4680216" "4803108" "5045575" "5071338" "5139843" "5344685" "5347098"); PN. OR ("5773047"); URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2008/10/21 09:50
S18	7	(EP-662380-\$ WO- 03051649-\$ EP- 365479-\$ EP-901849-\$ WO-02020261-\$).did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 09:55
S19	204	264/642.cds. and (adhesive or paste or glue or binder or resin or bonding) and (mold \$3 or model\$3 or tool \$3 or cast\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 09:57
S20	77	264/643.cds. and (adhesive or paste or glue or binder or resin or bonding) and (mold or model\$3 or tool\$3 or cast) not S19	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 09:57
S21	941	264/219.ccls. and (adhesive or paste or glue or binder or resin or bonding) and (layer \$3 or lamina\$4 or stack \$3 or multi\$1layer\$2 or lay\$1up or (lay\$3 up) or sheet or block)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 10:03
S22	135	\$21 and ((rapid prototyp\$3) or stereolithograph\$2 or (sheet laminat\$3) or (sheet molds3) or (building block) or SMP or (seamless model\$3) or (laminated object) or LCM)	US-PCPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 10:04

S23	46	264/220.cds. and (adhesive or paste or glue or binder or resin or bonding) and (layer \$3 or laminas\$4 or stack \$3 or multi\$11ayer\$2 or lay\$1up or (lay\$3 up) or sheet or block) and ((rapid prototyp\$3) or stereolithograph\$2 or (sheet laminat\$3) or (sheet mold\$3) or (building block) or SMP or (seamless model\$3) or (laminated object) or LOM) not \$22	US-PGPUB; US-PAT; US-COCR; FPRS; EPO; JPO; DEFEMBATT; IBM_TDB	ADJ	ON	2008/10/21
S24	21	156/153.cds. and (adhesive or paste or glue or binder or resin or bonding) and (layer \$3 or lamina\$4 or stack \$3 or multi\$11ayer\$2 or lay\$1up or (lay\$3 up) or sheet or block) and ((rapid prototyp\$3) or stereolithograph\$2 or (sheet laminat\$3) or (sheet mold\$3) or (building block) or SMP or (seamless model\$3) or (laminated object) or LOM) not \$22	US-PGPUB; USPAT; USOCR; PPRS, EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 10:22
\$25	21	156/154.cds. and (adhesive or paste or glue or binder or resin or bonding) and (layer \$3 or laminas*4 or stack \$3 or multi\$11ayer\$2 or lay\$1 up or (lay\$3 up) or sheet or block) and ((rapid prototyp\$3) or stereolithograph\$2 or (sheet laminat\$3) or (sheet laminat\$3) or (sheet mold\$3) or (cuiding block) or SMP or (seamless model\$3) or (laminated object) or LOM or (solid freeform)) not \$24	US POPUB; USPAT; USOCR; FPRS; EPO; JPO; DETWENT; IBM_TDB	ADJ	ON	2008/10/21 10:25

S26	58	156/278.cds. and (adnesive or paste or glue or binder or resin or bonding) and (layer \$3 or lamina\$4 or stack \$3 or multi\$11ayer\$2 or lay\$1up or (lay\$3 up) or sheet or block) and ((rapid prototyp\$3) or stereolithograph\$2 or (sheet laminat\$3) or (sheet laminat\$3) or (seamless model\$3) or (laminated object) or LCM or (solid freeform)	US-PAT, USCOR, FPPS, EPO; JPO; DEFEWENT; IBM_TDB	ADJ	ON	2008/10/21 10:30
\$27	45	156/280.cds. and (adhesive or paste or glue or binder or resin or bonding) and (layer \$3 or lamina\$4 or stack \$3 or multi\$11ayer\$2 or lay\$1up or (lay\$3 up) or sheet or block) and ((rapid prototyp\$3) or stereolithograph\$2 or (sheet laminat\$3) or (sheet mold\$3) or (sheet mold\$3) or (sheet mold\$3) or (Laminat\$4 object) or LCM or (solid freeform)) not \$26	US-PGPUB; USPAT; USCOR; FPRS, EPO; JPO; DEFEMENT; IBM_TDB	ADJ	ON	2008/10/21 10:34
\$28	187	156/295.cds. and (layer \$3 or lamina\$4 or stack \$3 or multi\$1layer\$2 or lay\$1up or (lay\$3 up) or sheet or block) and (mold or model or tool)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21
S29	13	\$28 and ((rapid prototyp\$3) or stereolithograph\$2 or (sheet laminat\$3) or (sheet mold\$3) or (building block) or \$MP or (seamless model\$3) or (laminated object) or LCM or (solid freeform)	US PCPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 10:38

330	72	("2750632" "2822448" "3153915" "3231341" "3292884" "3386503" "3410396" "3464854" "3607569" "3625659" "3635623" "3645899" "3835094" "3895162" "3904555" "4038444" "4049767" "4073049" "4102851" "4102851" "4165655" "4287115" "4375498" "4394340" "4366185" "4375498" "4394340" "4420395" "458305" "458305" "458305" "458305" "458305" "458305" "459305" "459305" "459305" "459305" "459305" "459305" "558305" "558586" "490629" "490629" "490629" "490629" "490629" "55075589" "5005756" "5007553" "5286210" "5503476" "55075265" "5507565" "5502753" "5286210" "5261634" "5298548" "5298548" "5290167" "5510007" "55476651" "557659160" "5760561" "5765966" "5763561" "5765966" "57635651" "5765966" "57635651" "5765966" "57635651" "5765966" "57635651" "5769666" "57635555" "5763566" "5763566" "5763566" "5763556" "5763566" "5763566" "5763566" "5763566" "5763566" "5763566" "5763566" "5763556" "5763566" "5763556" "5763566" "5763556" "5763566" "5763556" "5763556" "5763556" "5763566" "5763556" "5763566" "5763555" "5763556" "57635556" "5763556" "5763556" "5763556" "5763556" "5763556" "5763556" "	US-PGPUB; USPAT; USOCR	ADJ	ON	2008/10/21
		"5832981").PN. OR ("6309587").URPN.				
S31	67	epoxy with (dynamic viscosity)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 17:09

S32	17	("4349651" "4420605" "4358571" "4420605" "443094" "4430445" "4528305" "4659779" "4732962" "4732962" "4742148" "4925886" "493392" "588053" "5691402").PN. OR ("6060540").URPN.	US-PCPUB; USPAT; USOCR	ADJ	ON	2009/11/13 11:13
\$33	9	CLEAVER-MATTHEW\$.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 11:31
\$34	93	HUNTSWAN\$.AS. and (layer\$3 or lamina\$4 or stack\$3 or multi\$11ayer\$2 or lay\$1up or (lay\$3 up) or sheet or block) and (mold\$3 or model\$3 or tool \$3 or model\$3 or tool \$3 or oact\$30) and (adhesive or paste or glue or binder or resin or bonding or cement or epoxy) and (cover\$3 or coat\$3 or encapsulant or seat\$3 or encapsulant or seat\$3 or encapsulant or seat\$3 or encapsulant or ground or abrad\$3 or ground or abrad\$3 or or abrad\$3 or or abrad\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13
\$35	10	S34 and ((layer\$3 or lamina\$4 or stack\$5 or multi\$1 layer\$2 or lay \$1 up or (lay\$3 up) or sheet or block) with (mold\$3 or mould\$3 or mould\$3 or model\$3 or tool\$3 or cast\$3)) and ((adhesive or paste or glue or binder or resin or bonding or cement or epoxy) same (cover \$3 or coat\$3 or encapsulant or seal\$3 or encapsulant or seal\$3 or envelop\$5 or surround\$3) same (machin\$3 or grind\$3 or ground or abrad\$3 or ground or abrad\$3	US-PGPUB; USPAT; USCOR; FPFS; EPO; JPO; DEFWENT; IBM_TDB	ĀŌJ	ON	2009/11/13

6	26	156/153 cde and	LIC DODLIB:	ADI		2000/11/12
6	26	or abrasion or cuts4)) 156/153.cds. and ((adhesive or paste or glue or binder or resin or bonding or cement or epoxy) with (layer or layered or layered or layered or layered or layered or laminating or stack or stacked or stacking or multilayer or multilayer or lay up) or (layed up) or (laying up) or sheet or block) with (mold or moulding or moulding or model or modeling) and ((cover\$3 or coat \$3 or encapsula\$11\$3 or seal\$3 or envelop\$3 or surround\$3) with (adhesive or paste or glue or binder or resin or bonding or or durdening or set or seating) with (ambeint or resin or bonding or cement or epoxy)) and ((cure or cured or curing or hardening or set or seating) with (ambient or ((room or normal) near2 temperature))) and (thermocured or thermocuring or thermosettor or post\$1 cure or post\$1 cured or post\$1 cur	US-PCPUB; US-PAT; USOCR; FFFS; EPC, JPC; DETWENT; IBM_TDB	ADJ	ON	2009/11/13
	***************************************	\$1 hardening or ((latent or latency or latently or hot or heat or heated or heating or temperature or second or additional or final) with (cure or cured or curing or harden or hardened or hardening or set or setting)))		***************************************	***************************************	

37	14	156/154.cds. and	US-PGPUB;	A DJ	ON	2009/11/13
		((adhesive or paste or	USPAT; USOCR;			13:08
		glue or binder or resin	FPRS; EPO;		1	
		or bonding or cement	JPO;			
		or epoxy) with (layer	DERWENT;			
		or layered or layering	IBM TDB			
		or lamina or laminate	_			
		or laminated or			1	
		laminating or stack or				
		stacked or stacking or				
		multilayer or				
		multilayered or layup				
		or (lay up) or (layed			l	
		up) or (laying up) or				
		sheet or block) with				
		(mold or mould or				
		molding or moulding or			1	
		form or tool or tooling				
		or model or modeling))				
		and ((cover\$3 or coat				
		\$3 or encapsula\$1t\$3			1	
		or seal\$3 or envelop\$3			i	
		or surround\$3) with				
		(adhesive or paste or				
	-	glue or binder or resin				
		or bonding or cement				
		or epoxy)) and ((cure				
		or cured or curing or			i	
		harden or hardened or				
		hardening or set or			i	
		setting) with (ambient				
		or ((room or normal)			l	
		near2 temperature)))			1	
		and (thermocure or			1	
		thermocured or			i	
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		thermoset or			l	
		thermosetting or post				
		\$1cure or post\$1cures				
		or post\$1cured or post			i	
		\$1 curing or post				
		\$1harden or post			i	
		\$1hardens or post				
		\$1hardened or post				
		\$1hardening or ((latent			i	
		or latency or latently or			1	
		hot or heat or heated				
		or heating or				
		temperature or second			1	
		or additional or final)			1	
		with (cure or cured or			ĺ	
		curing or harden or			i i	
		hardened or hardening			1	
		or set or setting))) not				
	1	S36	1	1	1	1

38	5	156/244.12.ccls. and	US-PGPUB;	A DJ	ON	2009/11/13
		((adhesive or paste or	USPAT; USOCR;			13:11
		glue or binder or resin	FPRS; EPO;			
	-	or bonding or cement	JPO;			
		or epoxy) with (layer	DERWENT;			
		or layered or layering	IBM_TDB			
		or lamina or laminate	_			
		or laminated or				
		laminating or stack or				
		stacked or stacking or				
		multilayer or				
		multilayered or layup				
		or (lay up) or (layed				
		up) or (laying up) or			į	
		sheet or block) with				
		(mold or mould or				
		molding or moulding or				
		form or tool or tooling		***************************************		
		or model or modeling))		***************************************	-	
		and ((cover\$3 or coat		***************************************		
		\$3 or encapsula\$1t\$3				
		or seal\$3 or envelop\$3				
		or surround\$3) with				
		(adhesive or paste or				
		glue or binder or resin				
		or bonding or cement				
		or epoxy)) and ((cure				
		or cured or curing or				
		harden or hardened or			į	
		hardening or set or				
		setting) with (ambient				
		or ((room or normal)				
		near2 temperature)))				
		and (thermocure or			į	
		thermocured or				
		thermocuring or			į.	
		thermoset or				
		thermosetting or post				
		\$1 cure or post\$1 cures		***		
		or post\$1cured or post				
	-	\$1 curing or post				
		\$1harden or post				
		\$1hardens or post				
		\$1hardened or post				
		\$1hardening or ((latent			i	
		or latency or latently or		***		
		hot or heat or heated				
		or heating or				
		temperature or second		****	-	
		or additional or final)				
		with (cure or cured or				
		curing or harden or		***************************************		
		hardened or hardening			į	
		or set or setting))) not		***		
	1	(S36 or S37)		1	1	1

339	25	156/278.cds. and ((adhesive or paste or glue or binder or resin or bonding or cement or epoxy) with (layer or layered or layered or layering or laminate or laminating or stack or stacked or stacked or stacking or multilayer or multilayer or (lay up) or (layed up) or (laying up) or sheet or block) with (mold or mould or molding or modeling) and ((cover\$3 or coat)	US-PGPUB; USPAT; USOCR; FPTS; EPC; JPC; DEFWENT; IBM_TDB	ADJ	ON	2009/11/13 13:12
		\$3 or encapsula\$1t\$3 or seal\$3 or envelop\$3 or surround\$3) with (adhesive or paste or glue or binder or resin or bonding or cement or epoxy)) and ((cure or cured or curing or harden or hardened or hardening or set or setting) with (ambient or ((room or normal) near2 temperature))) and (thermocured or thermocured or thermoset or thermoset or some or post \$1 cure or				
		\$1harden or post \$1hardens or post \$1hardening or ((latent or latency or latently or hot or heat or heated or heating or temperature or second or additional or final) with (cure or cured or curing or harden or hardened or hardening or set or setting))) not (S36 or S37 or S38)		***************************************		

S40	25	156/280.cds. and ((adhesive or paste or	US-PGPUB; USPAT; USOCR; FPRS; EPO;	ADJ	ON	2009/11/13 13:17
		glue or binder or resin or bonding or cement	JPO;			
		or epoxy) with (layer	DERWENT;			
		or layered or layering	IBM TDB			
		or lamina or laminate	IDIVI_100			
		or laminated or				
		laminating or stack or				
		stacked or stacking or			į	
		multilayer or				
		multilayered or layup			i i	
		or (lay up) or (layed			i	
		up) or (laying up) or			i	
		sheet or block) with (mold or mould or				
		molding or moulding or				
		form or tool or tooling				
		or model or modeling))				
		and ((cover\$3 or coat				
		\$3 or encapsula\$1t\$3				
		or seal\$3 or envelop\$3				
		or surround\$3) with				
		(adhesive or paste or				
		glue or binder or resin			į	
		or bonding or cement or epoxy)) and ((cure			į	
		or cured or curing or			į	
		harden or hardened or			į	
		hardening or set or				
		setting) with (ambient				
		or ((room or normal)				
		near2 temperature)))			ĺ	
		and (thermocure or				
		thermocured or				
		thermocuring or thermoset or				
		thermosetting or post				
		\$1 cure or post\$1 cures				
		or post\$1cured or post				
		\$1 curing or post				
		\$1harden or post				
		\$1hardens or post				
		\$1hardened or post				
		\$1hardening or ((latent				
		or latency or latently or hot or heat or heated				
		or heating or				
		temperature or second				
		or additional or final)			•	
		with (cure or cured or				
		curing or harden or				
		hardened or hardening		-		
		or set or setting))) not				
		(S36 or S37 or S38 or				
	,	S39)		1		1

341	4	264/642.cds. and	US-PGPUB;	A DJ	ON	2009/11/13
		((adhesive or paste or	USPAT; USOCR;			13:28
		glue or binder or resin	FPRS; EPO;	******	1	
		or bonding or cement	JPO;			
		or epoxy) with (layer	DERWENT;			
		or layered or layering	IBM_TDB			
		or lamina or laminate				
		or laminated or				
		laminating or stack or				
		stacked or stacking or				
		multilayer or				
		multilayered or layup				
		or (lay up) or (layed				
		up) or (laying up) or				
		sheet or block) with				
		(mold or mould or				
		molding or moulding or				
		form or tool or tooling				
		or model or modeling))		***	ĺ	
		and ((cover\$3 or coat			i i	
		\$3 or encapsula\$1t\$3				
		or seal\$3 or envelop\$3			i i	
		or surround\$3) with				
		(adhesive or paste or glue or binder or resin				
		or bonding or cement				
		or epoxy)) and ((cure				
		or cured or curing or				
		harden or hardened or				
		hardening or set or				
		setting) with (ambient				
		or ((room or normal)				
		near2 temperature)))				
		and (thermocure or				
		thermocured or			l l	
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		\$1hardened or post				
		\$1hardening or ((latent				
		or latency or latently or		***		
		hot or heat or heated			l l	
		or heating or				
		temperature or second				
		or additional or final)			i i	
		with (cure or cured or		***	•	
		curing or harden or			•	
		hardened or hardening				
		or set or setting))) not				
		(S36 or S37 or S38 or			1	
		S39 or S40)				

S42	2	264/643.cds. and ((adhesive or paste or	US-PGPUB; USPAT; USOCR;	ADJ	ON	2009/11/13
		glue or binder or resin	FPRS; EPO;			10120
		or bonding or cement	JPO;			
		or epoxy) with (layer	DERWENT:			
		or layered or layering	IBM TDB			
		or lamina or laminate	IDIVI_IDD			
		or laminated or			İ	
		laminating or stack or				
		stacked or stacking or multilayer or				
		multilayered or layup				
		or (lay up) or (layed				
		up) or (laying up) or				
		sheet or block) with				
		(mold or mould or				
		molding or moulding or form or tool or tooling				
		or model or modeling))				
		and ((cover\$3 or coat \$3 or encapsula\$1t\$3				
		or seal\$3 or envelop\$3			i	
					i	
		or surround\$3) with (adhesive or paste or				
		alue or binder or resin				
					i	
		or bonding or cement			i	
		or epoxy)) and ((cure or cured or curing or				
		harden or hardened or			İ	
					i	
		hardening or set or setting) with (ambient				
		or ((room or normal)				
		near2 temperature)))				
		and (thermocure or				
		thermocured or			1	
		thermocuring or				
		thermoset or				
		thermosetting or post				
		\$1 cure or post\$1 cures			ĺ	
	-	or post\$1cured or post \$1curing or post			1	
					ĺ	
		\$1harden or post \$1hardens or post			1	
		\$1 hardens or post \$1 hardened or post				
		\$1hardening or ((latent			i	
		or latency or latently or			ĺ	
		hot or heat or heated				
		or heating or				
		temperature or second			i i	
		or additional or final)			1	
		with (cure or cured or				
		curing or harden or			1	
		hardened or hardening				
		or set or setting))) not				
		(S36 or S37 or S38 or				
	1	S39 or S40)	1	1	- (1

343	43	264/219.cds. and	US-PGPUB;	A DJ	ON	2009/11/13
		((adhesive or paste or	USPAT; USOCR;		1	13:29
		glue or binder or resin	FPRS; EPO;		1	
		or bonding or cement	JPO;			
		or epoxy) with (layer	DERWENT;			
		or layered or layering	IBM_TDB			
		or lamina or laminate				
		or laminated or				
		laminating or stack or				
		stacked or stacking or				
		multilayer or				
		multilayered or layup or (lay up) or (layed				
		up) or (lay up) or (layed up) or (laying up) or			1	
		sheet or block) with			l	
		(mold or mould or				
		molding or moulding or				
					i	
		form or tool or tooling or model or modeling))		***************************************		
		and ((cover\$3 or coat			ĺ	
		\$3 or encapsula\$1t\$3			1	
		or seal\$3 or envelop\$3				
		or surround\$3) with				
		(adhesive or paste or				
		alue or binder or resin				
		or bonding or cement				
		or epoxy)) and ((cure				
		or cured or curing or				
		harden or hardened or				
		hardening or set or			i	
		setting) with (ambient				
		or ((room or normal)			i	
		near2 temperature)))				
		and (thermocure or				
		thermocured or			i	
		thermocuring or				
		thermoset or			1	
		thermosetting or post				
		\$1 cure or post\$1 cures			İ	
		or post\$1cured or post		***************************************	ĺ	
		\$1curing or post			i	
		\$1harden or post			ĺ	
		\$1hardens or post				
		\$1hardened or post			ĺ	
		\$1hardening or ((latent				
		or latency or latently or		***	İ	
		hot or heat or heated		***	i i	
		or heating or			1	
		temperature or second				
		or additional or final)			i i	
		with (cure or cured or		***	1	
		curing or harden or			•	
		hardened or hardening				
		or set or setting))) not			i i	
		(S36 or S37 or S38 or			1	
		S39 or S40)	***	1	1	1

344	18	264/220.cds. and	US-PGPUB;	ADJ	ON	2009/11/13
		((adhesive or paste or	USPAT; USOCR;			13:42
		glue or binder or resin	FPRS; EPO;		•	
		or bonding or cement	JPO;			
		or epoxy) with (layer	DERWENT:			
		or layered or layering	IBM TDB			
		or lamina or laminate				
		or laminated or				
		laminating or stack or				
		stacked or stacking or				
		multilayer or				
		multilayered or layup				
		or (lay up) or (layed				
		up) or (laying up) or				
		sheet or block) with				
		(mold or mould or				
		molding or moulding or				
		form or tool or tooling				
		or model or modeling))			•	
		and ((cover\$3 or coat				
		\$3 or encapsula\$1t\$3			ŧ	
		or seal\$3 or envelop\$3		-		
		or surround\$3) with				
		(adhesive or paste or				
		glue or binder or resin				
		or bonding or cement				
		or epoxy)) and ((cure				
		or cured or curing or			i	
		harden or hardened or				
		hardening or set or				
		setting) with (ambient				
		or ((room or normal)				
		near2 temperature)))				
		and (thermocure or				
		thermocured or				
		thermocuring or				
		thermoset or				
		thermosetting or post			l l	
		\$1 cure or post\$1 cures				
		or post\$1 cured or post				
		\$1 curing or post				
		\$1 harden or post \$1 hardens or post				
		\$1hardens or post				
		\$1hardened or post \$1hardening or ((latent			i	
		or latency or latently or				
		hot or heat or heated			i	
		or heating or				
		temperature or second			•	
		or additional or final)				
		with (cure or cured or				
					i i	
		curing or harden or			•	
		hardened or hardening				
		or set or setting))) not (S36 or S37 or S38 or				
	1	S39 or S40 or S43)	\$	\$	1	1

345	12	264/221.cds. and	US-PGPUB;	A DJ	ON	2009/11/13
		((adhesive or paste or	USPAT; USOCR;			13:45
		glue or binder or resin	FPRS; EPO;			
		or bonding or cement	JPO;			
		or epoxy) with (layer	DERWENT;			
		or layered or layering	IBM_TDB			
		or lamina or laminate				
		or laminated or				
		laminating or stack or				
		stacked or stacking or				
		multilayer or				
		multilayered or layup				
		or (lay up) or (layed up) or (laying up) or				
		sheet or block) with			i	
		(mold or mould or				
		molding or moulding or				
		form or tool or tooling				
		or model or modeling))				
		and ((cover\$3 or coat				
		\$3 or encapsula\$1t\$3				
		or seal\$3 or envelop\$3				
		or surround\$3) with				
		(adhesive or paste or				
		glue or binder or resin				
		or bonding or cement				
		or epoxy)) and ((cure				
		or cured or curing or			į	
		harden or hardened or				
		hardening or set or				
		setting) with (ambient				
		or ((room or normal)				
		near2 temperature)))				
		and (thermocure or thermocured or				
		thermocuring or				
		thermoset or				
		thermosetting or post				
		\$1 cure or post\$1 cures			i	
		or post\$1 cured or post				
		\$1 curing or post				
		\$1harden or post				
		\$1hardens or post				
		\$1hardened or post				
		\$1hardening or ((latent				
		or latency or latently or				
		hot or heat or heated				
		or heating or				
		temperature or second				
		or additional or final)				
		with (cure or cured or			-	
		curing or harden or				
		hardened or hardening				
		or set or setting))) not				
		(S36 or S37 or S38 or				
	1	S39 or S40 or S43 or	1			1

S46	241	("0408677"	US-PGPUB;	A DJ	ON	2009/11/13
		"0460377" "1164987"	USPAT; USOCR			14:43
		"20010031531"				
		"20010034114"				
		"20020093115"		***		
		"20020149137"				
		"20020181647"				
		"20030128812"				
		"20030128813"		***		
		"20040006405"				
		"20040128016"				
		"20050206048"				
		"20070036844"		***		
		"20070158014"				
		"3379812" "3676541"				
		"3829536"				
		"3964534" "4288697"		***		
		"4355400"				
		"4356400" "4465540"		***		
		"4748328"				
		"4801379" "4812236"				
		"4825646"				
		"4856043" "4915757"		***		
		"4951305"				
		"5002889" "5017317"				
		"5043043"				
		"5088047" "5126529"		**		
		"5127037"				
		"5147761" "5150183"				
		"5183598"				
		"5190637" "5192559"				
		"5203944"				
		"5206983" "5207371"				
		"5208431"				
		"5216616" "5252881"				
		"5286573"				
		"5301863" "5306447"				
		"5348693"		***		
		"5378583" "5398193"				
		"5447068"				
		"5450183" "5450751"				
		"5459320"				
		"5483387" "5514232"				
		"5551904"				
		"5555481" "5559708"				

		"5576147" "EFOCEO4" "FCCCEOO"				
		"5596504" "5606589"			İ	
		"5620854" "E627160" "E620212"				
		"5637169" "5638212"			1	
		"5644177"				
		"5681661" "5692507"				
		"5702384"				
		"5718618" "5721687"				
		"5729585"				
		"5763318" "5773116"				
		"5778468"				
	i	"5786597" "5795748"	\$	1	1	1

"5814235"
"5814807" "5836150"
"5849229"
"5851897" "5855718"
"5879489"
"5902538" "5924277"
"5925308"
"5929446" "5932940" "5949850"
"5949850" "5955801" "5955818"
1 "5962949" I
"5963788" "5985204"
"5994801"
"5994816" "5998260"
"6004500 ["]
"6007765" "6011265"
"6014419"
"6017410" "6018422"
"6018566"
"6018680" "6021358"
"6055899" "6068684" "6075840"
"6084626"
"6084980" I "6088102"
l "6124663" I
"6126775" "6133670"
"6134294"
"6149160").PN. OR
("6152181"
"6155634" "6159407" "6165406"
"6165406" "6175615" "6179601"
"6185278"
"6188743" I "6190594"
"6193923"
"6197180" "6210644"
"6219015"
"6226120" "6230408"
"6241934"
"6242163" "6245184"
"6245249" "6245487" "6245849"
"6250070"
"6252938" "6261066"
"6261506"
"6270335" "6276313"
"6280090"
"6299300" "6307815"
"6310419"
"6314887" "6318069"
"6318849" "6324748" "6328903"
"6324748" "6328903" "6333584"
"6336318" "6338199"
"6338249"
"6340222" "6344392"
"6346030"

"6350983" "6352656"
"6360424"
"6363712" "6363843"
"6367911"
"6373158" "6375871"
"6376148"
"6381846" "6382588"
"6386015"
"6387713" "6392187"
"6392313"
"6392524" "6393685"
"6395126"
"6396677" "6397677"
"6397793"
"6398490" "6399010"
"6401004"
"6404942" "6406658"
"6408884"
"6409072" "6410213"
"6415860"
"6416168" "6433657"
"6438210"
"6440284" "6445840"
"6447727"
"6450047" "6453083"
"6454945"
"6457629" "6458263"
"6462858"
"6463349" "6467138"
"6468309"
"6471471" "6471800"
"6472459"
"6480320" "6490496"
"6505089" "6508971" "6519500"
"6557607" "6575218" "6611731"
"6627030"
"6627835" "6660209"
"6682688"
"6713199" "6731438"
"6745446"
"6780368" "6812061"
1
"6829536" "6881950" "7057245"
"7077638"
"7141080" "7170140"
1 "7203569" I
"7235166" I
"7252861").PN. OR
("7410606").URPN.
,,

\$47	6	S46 and ((cover\$3 or coat\$3 or encapsula\$11 \$3 or seal\$3 or envelop \$3 or surround\$3) with epoxy) and ((cure or cured or curing or harden or hardened or hardened or hardened or hardened or thermocure or thermocured or thermocured or thermocured or thermocured or thermocured or thermocured or struce or post\$1 cured or cured or cured or cured or cured or cured or cured or cured or cured or cured or cured or cured or set or setting))) not \$1 cured or \$1 cured o	US-PAT-USCOR, FPRS, EPO; JPO; DEFEMBATT; IBM_TDB	ADJ	ON	2009/11/13
S48	12	("4048709" "4086118" "4073049" "4086118" "4466936" "4601867" 4834929 "4925611" "4929403" "5120480" "5215699" "5904986"),FN. OR ("6352609"),URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/11/13 14:54

S49	13525	((rapid prototyp\$3) or stereolithograph\$2 or (sheet laminat\$3) or (sheet mold\$3) or (sheet mold\$3) or (louiding blook) or SMP or (seamless model\$3) or (laminated object) or LCM or (solid freeform) or (size near2 (cast or casting))) and ((adhesive or paste or glue or binder or resin or bonding or cement or epoxy) with (layer or layered or layering or laminated or laminated or laminated or laminated or laminated or laminated or laminated or laminated or laminated or laminated or laminated or laminated or laminating or stacked or stacking or multilayered or layer or (laying) or (layed up) or (laying up) or (laying up) or sheet or block) with (mold or mould or modeling)) and ((cover\$3 or envelop\$3 or sauf\$5 or envelop\$3 or sauf\$5 or envelop\$3 or sauf\$7 or envelop\$3 or solid or bonding or cement or opoxy)) not (S86 or S87 or S88 or S84 or S48 or S45 or S47 or S48)	USPAT, USOA; FPRS, EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13
\$50	2317	S49 and (((cover\$3 or coat\$3 or encapsula\$1† \$3 or seal\$3 or envelop \$3 or surround\$3) with (adhesive or paste or glue or binder or resin or bonding or cement or epoxy)) same (machine or machining or grind or grinding or ground or abrade or abraded or abrading or commercial or numerical or numerical or numerically))	US-PG-PUB; US-PG-I USOCR; FPRS; EPO; JPO; DET-MVB-NT; IBM_TDB	ADJ	ON	2009/11/13 15:03

\$51	252	SSO and ((cure or cured or curing or harden or hardens or hardens or hardens or hardens or nearly set or setting) with (ambient or ((room or normal) near2 temperature))) and (thermocured or thermocured or thermoset or thermoset or thermoset or or post\$1 cures or post\$1 cures or post\$1 cures or post\$1 cured or post\$1 curing or post\$1 hardens or post\$1 hardens or post\$1 hardens or post\$1 hardens or post\$1 hardens or post\$1 hardens or post\$1 hardens or nest or latency or latently or temperature or second or additional or final) with (cure or cured or curing or harden or hardens or setting)))	US POPUB; USPAT; USOOR; FPRS; EPO; JPO; DEFWENT; IBM_TDB	ADJ	ON	2009/11/13
S52	32	S51 and "156".clas.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 15:04
S53	192	S51 and epoxy	US PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 15:05
S54	40	S51 and "264".clas.	US PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 15:08
S55	12	("5330343" "5651806" "5906667" "6021358" "6116888" "6192327").PN.	US PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 15:11

12/7/2009 9:47:07 AM

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